60V Current Mode Buck Controller with Accurate Current Report

General Description

The MAX15157B belongs to the family of MAX15157 4-switch, buck–boost controllers. MAX15157B drives two external MOSFETs in half-bridge buck configuration. The output voltage can be dynamically set through the 1V to 2.2V reference input (REFIN) for modular design support.

The switching frequency is controlled either through an external resistor that sets the internal oscillator frequency, or by synchronizing the regulator to an external clock. The device is designed to support 120kHz to 1MHz switching frequencies. The controller has a dedicated undervoltage-lockout pin (UVLO) and an accurate enable-input threshold for flexible power-sequence configuration. The controller also has multiple fault-protection circuits to protect against overcurrent (OCP), output overvoltage (OVP), input UVLO and thermal shutdown.

The MAX15157B features an adjustable internal compensation ramp. The device incorporates an accurate current-sense amplifier that reports output current through an analog output (IMON). The device allows single-phase or multiphase (up to four-phase) operation.

The device is footprint compatible with MAX15157 and is available in a 5mm x 5mm, 32-pin TQFN package and supports a -40° C to $+125^{\circ}$ C junction temperature range.

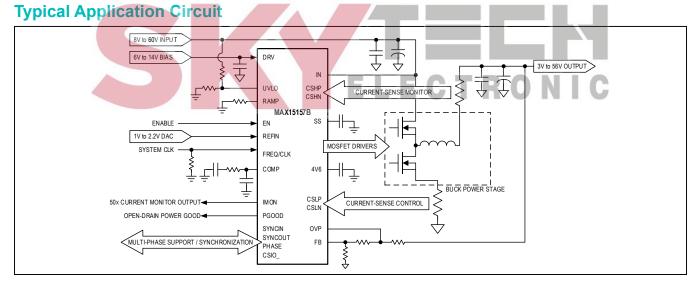
Ordering Information appears at end of data sheet.

Benefits and Features

- Wide Operating Range Reduces Development Time
 - 8V to 60V Input-Voltage Range
 - 3V to 56V Output-Voltage Range
 - 120kHz to 1MHz Switching-Frequency Range
 - -40°C to +125°C Temperature Range
- Integration Reduces Design Footprint
 - Internal LDO for Bias-Supply Generation
 - Synchronization Input
 - Current-Monitor Output
- Robust Fault Protection Improves Quality and Simplifies System Design
 - Adjustable Input Undervoltage Lockout
 - Average and Cycle-by-Cycle Overcurrent Protection
 - Input Undervoltage-Fault Protection
 - Multiple Levels of Overvoltage Protection
 - Thermal Shutdown
- Adjustable Slope Compensation
- Multiphase Support
- Small 5mm x 5mm, 32-pin TQFN, 0.5mm Pitch

Applications

- Communication
- Industrial
- Automotive





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Absolute Maximum Ratings

IN to PGND	0.3V to +65V
CSLP, CSLN to PGN	ID0.3V to +0.3V
CSLP to CSLN	-0.3V to +0.3V
CSHP, CSHN to PG	ND0.3V to +65V
CSHP to CSHN	0.3V to +0.3V
LX to PGND	1.0V to +65V
LX + DRV	
LX to PGND less that	an 50ns2V
BST to PGND	-0.3V to +80V
	-0.3V to +16V
DH to LX	-0.3V to (V _{BST} + 0.3V)
DL to PGND	-0.3V to (V _{DRV} + 0.3V)
DRV to PGND	-0.3V to +16V
	-0.3V to +6V
DRV to 4V6	-0.3V to +16V

EN, FB, PGOOD, REFIN to AGND0	
UVLO, OVP, FREQ/CLK, SYNCIN to AGND0).3V to +6V
COMP, SS, IMON, RAMP to AGND0.3V to (V2	_{4V6} + 0.3V)
SYNCOUT, PHASE to AGND0.3V to (V2	_{1V6} + 0.3V)
CSION, CSIOP to AGND0.3V to (Vz	_{1V6} + 0.3V)
PGND to AGND0.3	3V to +0.3V
Maximum Current out of 4V6	100mA
Operating Temperature Range40°C	to +125°C
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
TQFN (derate 34.5mV/°C above +70°C)0.3	3V to +0.3V
Junction Temperature	+150°C
Storage Temperature Range40°C	
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+240°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

32 TQFN

Package Code	T3255+4
Outline Number	<u>21-0140</u>
Land Pattern Number	<u>90-0012</u>
THERMAL RESISTANCE, SINGLE-LAYER	BOARD
Junction to Ambient (θ_{JA})	+29°C/W
Junction to Case (θ _{JC})	+1.7°C/W

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

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Electrical Characteristics

 $(V_{IN} = 35V, V_{DRV} = 9V, V_{EN} = V_{UVLO} = 3.3V, OVP = GND, REFIN = 4V6, R_{FREQ} = 100k\Omega$ (600kHz), $C_{4V6} = 4.7\mu$ F, $C_{SS} = 10$ nF, $T_A = T_J = -40^{\circ}$ C to +125°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
INPUT SUPPLIES	1		1				
		1-phase operation	6		60	.,	
IN Operating Range	VIN	Multiphase operation	8		60	- V	
DRV Operating Range	V _{DRV}		5.6		14	V	
IN Quiescent Current	I _{IN}	Not switching, including current- reporting bias current		504	950	μA	
IN Shutdown Current	IIN(SHDN)	EN = AGND		2.6	8.0	μA	
DRV Quiescent Current	IDRV	Not switching		4.8	8.0	mA	
DRV Shutdown Current		EN = AGND		18	43	μA	
IN Undervoltage-Lockout		V _{IN} rising	5.2	5.3	5.4		
Threshold	V _{IN(UVLO)}	V _{IN} falling	5.0	5.1	5.2	V	
DRV Undervoltage-Lockout		V _{DRV} rising	5.05	5.18	5.30		
Threshold	VDRV(UVLO)	V _{DRV} falling	5.0	5.1	5.2	V	
4V6 BIAS LINEAR REGULATOR							
Bias LDO Output Voltage	V4V6	No load	4.45	4.55	4.65	V	
Bias LDO Current Limit			31	48	87	mA	
4V6 Undervoltage-Lockout	V _{4V6} (UVLO)	V _{4V6} rising	4.15	4.30	4.37	- V	
Threshold		V _{4V6} falling	4.10	4.21	4.32		
CONTROLLER ENABLE	1		L				
		EN rising	0.66	0.70	0.75		
EN Logic Threshold	V _{EN}	EN falling, after LDO in regulation	0.48	0.55	0.60	V	
EN Input-Leakage Current	I _{EN}	V _{EN} = 0V to 5V	-1		+1	μA	
UVLO Adjustable Undervoltage-		V _{UVLO} rising	0.965	1.000	1.035		
Lockout Threshold	VUVLO	V _{UVLO} falling	0.865	0.900	0.935	V	
UVLO Input-Leakage Current	IUVLO	$V_{UVLO} = 0V \text{ to } 4.6V$	-200		+200	nA	
UVLO Deglitch Time				20	50	μs	
CONTROL LOOP	·	·					
FB Regulation Threshold		REFIN = 4V6	1.98	2.00	2.02		
(Preset Mode)	V _{FB}	REFIN = 4V6, T _J = +25°C	1.993	2.000	2.007	V	
FB-to-REFIN Offset Voltage (Tracking Mode)		V _{FB} - V _{REFIN} , V _{REFIN} = 1V to 2.2V	-4.0		+4.0	mV	
REFIN Input-Voltage Range	V _{REFIN}	(Note 2)	1		2.2	V	
Dreast Made DEEN Threader's		REFIN rising	2.30	2.35			
Preset Mode REFIN Threshold		REFIN falling	2.22	2.25		V	

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Electrical Characteristics (continued)

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PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
FB Input-Leakage Current	I _{FB}	V _{FB} = 0V to 2.2V	-200		+200	nA
REFIN Input-Leakage Current	IREFIN	V _{REFIN} = 1V to 2.2V	-100		+100	nA
Low-Side Current-Sense Differential Voltage Range	ΔV _{CSL}	V _{CSLP} - V _{CSLN}		±200		mV
Low-Side Curr <mark>ent-Se</mark> nse Common-Mod <mark>e Volt</mark> age Range	V _{CSL}	With respect to AGND		±300		mV
CSL_ Input-Leakage Current	I _{CSL}		-0.8		+0.8	μA
CSL_Current-Sense Amplifier Gain	A _{CSL_}			4.9		V/V
Error-Amplifier Transconductance	G _{MEA}			1.1		mS
Slope-Compensation Ramp- Amplitude Adjustable Range	VRAMP		190		590	mV
RAMP Pin Input-Voltage Range	V _{RAMP_PIN}		120		380	mV
V _{RAMP} -to-Internal Compensation RAMP Voltage Ratio		V _{RAMP} = 0.3V		1.55		V/V
RAMP Bias Current	IRAMP	V _{RAMP} = 0V	5.4	6.0	6.6	μA
SWITCHING FREQUENCY						
Preset Switching Frequency	fsw	R_{FREQ} = open, R_{PHASE} = 270 Ω	290	300	310	kHz
Adjustable Switching Frequency	f	R _{FREQ} = 25kΩ	132	142	152	- kHz
	f _{SW}	R _{FREQ} = 100kΩ	550	586	620	
Synchronization Range	fsw	FREQ/CLK driven by external clock	120	- 1	1000	kHz
CLK Frequency-Detection Range	fCLK		0.24		6.00	MHz
CLK Logic Level	Maria	Logic-high (rising)		1.8	1.95	v
OEIX LOGIC LEVEL	VCLK	Lo <mark>gic-low</mark> (falling)	1.2	1.6		· ·
FREQ/CLK Input Bias Current	ICLK	V _{FREQ/CLK} = AGND	-10.5	-9.8	-9.2	- μΑ
	'CLK	V _{FREQ/CLK} = 4V6		0.5		μ.,
		R _{PHASE} = 270kΩ (1 phase)		2		
CLK Switching Frequency-Divider Ratio	f _{CLK} /f _{SW}	R _{PHASE} = 133kΩ (2 phase)		2		kHz/kHz
		R _{PHASE} = 169kΩ (3 phase)		6		
		$R_{PHASE} = 210 k\Omega (4 \text{ phase})$		4		

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Electrical Characteristics (continued)

 $(V_{IN} = 35V, V_{DRV} = 9V, V_{EN} = V_{UVLO} = 3.3V, OVP = GND, REFIN = 4V6, R_{FREQ} = 100k\Omega (600kHz), C_{4V6} = 4.7\mu F, C_{SS} = 10nF, T_A = T_J = -40^{\circ}C \text{ to } +125^{\circ}C, \text{ unless otherwise noted.}) (Note 1)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SYNCHRONIZATION and PHASE		·				
		Logic-high (rising)		1.59	1.92	
SYNCIN Logic Threshold	VSYNCIN	Logic-low (falling)	0.90	1,14		- V
SYNCIN Input-Leakage Current	ISYNCIN	V _{SYNCIN} = 0V to 4.6V	-0.1		+0.1	μA
SYNCIN Frequency Range	f SYNCIN		0.24		6.00	MHz
SYNCOUT Output-Voltage Level	V _{SYNCOUT} - V _{4V6}	Logic-high, I _{SOURCE} = 10mA	4V6 - 0.4			v
	VSYNCOUT	Logic-low, I _{SINK} = 10mA			0.4]
PHASE Source Current	I _{PHA} SE		9.2	10	10.8	μA
		2-phase (133kΩ)	1.28		1.38	
	VDHAGE	3-phase (169kΩ)	1.63		1.73	
PHASE Voltage Levels	V _{PHASE}	4-phase (210kΩ)	2.04		2.14	V
		1-phase (270kΩ)	2.48			1
OUTPUT-FAULT PROTECTION						
CSL_ Cycle-by-Cycle Current-		Low-side FET ON	-46	-41	-36	mV
Limit Threshold		Low-side FET ON	31	40	49	mV
CSL_ Hiccup Current-Limit		Low-side FET ON	-71	-62	-51	mV
Threshold		Low-side FET ON	51	61	71	mV
Minimum REFIN and SS Voltage for Valid FB Faults		REFIN = SS	0.998	1.020	1.030	v
FB Undervoltage Threshold (Preset Mode)	FB_UV	Measured with respect to target voltage (REFIN = 4V6 and VREFIN = 2V), V _{FB} falling, 3% hysteresis	-8	-9	-10	%
FB Undervoltage Threshold (Tracking Mode)	FB_UV	Measured with respect to target voltage (V _{REFIN} = 1.2V), V _{FB} falling, 3% hysteresis	-8	0-9	-10	%
FB Overvoltage Threshold (Preset Mode)	FB_OV	Measured with respect to target voltage (REFIN = 4V6 and V _{REFIN} = 2V), V _{FB} falling, 3% hysteresis	+8	9	+10	%
FB Overvoltage Threshold (Tracking Mode)	FB_OV	Measured with respect to target voltage (V _{REFIN} = 1.2V), V _{FB} falling, 3% hysteresis	+8	9	+10	%
Adjustable Overvoltage-Protection	Veve	V _{OVP} rising	1.96	2.00	2.04	v
Threshold	V _{OVP}	V _{OVP} falling	1.86	1.90	1.94	v v
Overvoltage-Protection Input- Leakage Current	I _{OVP}	$V_{OVP} = 0V$ to 4.6V	-200		+200	nA

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Electrical Characteristics (continued)

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PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Fixed-Output Overvoltage- Protection Threshold	V _{OVP(CSH_)}	V _{CSHN} rising, 2.9V hysteresis	63.5	65.0	68.0	V
		UVP falling edge		34		
		OVP rising edge		20		μs
Fault Propaga <mark>tion D</mark> elay		Consecutive cycle-by-cycle CSL_ current-limit events		4		Cycles
		IMON average OCP, EXT UVLO, EXT OVLO, FB_OV, FB_UV		20		μs
PGOOD Startup Delay		Startup delay		64		CLK cycles
PGOOD Output-Low Voltage	V _{PGOOD}	I _{SINK} = 3mA		38	75	mV
PGOOD Leakage Current	IPGOOD	FB = REFIN (PGOOD in high- impedance state), V_{PGOOD} = 5V, T_A = +25°C		0.01	1.00	μA
Thermal Shutdown	TSHDN	15°C hysteresis		165		°C
SOFT-START and HICCUP						•
SS Amplifier Transconductance	G _{M(SS)}			0.2		mS
		Source	4.8	5.0	5.2	
SS Current Capability	I _{SS}	Sink	-5.5	-5.0	-4.2	- μΑ
SS Pulldown Resistance	R _{SS}	Discharge		5		Ω
SS Undervoltage-Lockout		SS rising		50		
Threshold	VUVLO(SS)	SS falling (drivers disabled) 10			– mV	
Hiccup Autoretry Period				32,768		CLK cycles
MOSFET DRIVERS		ELEC	TD	O N		
Low-Side Driver (DL)		Pullup E E E U		2		
On-Resistance	R _{DL}	Pulldown		0.6		Ω
High-Side Driver (DH)		Pullup		2		
On-Resistance	R _{DH}	Pulldown		0.6		Ω
DH Minimum On-Time	t _{DH}	(Note 3)		80		ns
DL Minimum On-Time	t _{DL}	(Note 3)		85		ns
Driver Rise Time		C _{LOAD} = 3nF (Note 3)		20		ns
Driver Fall Time		C _{LOAD} = 3nF (Note 3)		10		ns
DH-to-DL Dead-Time Delay		C _{LOAD} = 3nF		20		ns
DL-to-DH Dead-Time Delay	1	C _{LOAD} = 3nF		20		ns

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Electrical Characteristics (continued)

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PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
BST-to-LX Operating Range	V _{BST}		4.5		14	V
BST Quiescent Current	IBST	EN = AGND, LX = PGND, V _{BST} = 9V		42	65	μA
CURRENT MONITOR						
Current Report Multiphase V _{IN} UVLO		V _{IN} rising, current report and multiphase operation enabled 250mV hysteresis	7.30	7.45	7.60	v
CSH_ High-Side Current-Sense Common-Mode Voltage Range	V _{CSH} _	With respect to AGND			60	V
CSH_ High-Side Current-Sense Differential Voltage Range	ΔV _{CSH} _	Current-monitor range, VCSHP - VCSHN	0		50	mV
CSHP Input Bias Current	ICSHP	V _{CSHP} = 60V		72	120	μA
CSHN Input Bias Current	ICSHN	V _{CSHN} = 60V		52	95	μA
Current-Monitor Amplifier Gain	A _{CSH} _	V _{IMON} /ΔV _{CSH} _		50		V/V
Current-Monitor Amplifier Accuracy	VIMON	$V_{CSH} = \Delta V_{CSH} = 30 \text{mV}$	1.41	1.50	1.59	v
IMON Average Current-Limit Threshold	VOCP(AVE)		2.45	2.50	2.55	V
IMON Output Resistance		(Note 3)		0.5		Ω
IMON Amplifier Output Capacitive Load Stability	C _{IMON}	No sustained oscillations		200		pF
CURRENT SHARING (MULTIPHAS	SE APPLICATIO	ONS ONLY)	_	_		
CSH_ High-Side Current-Sense Differential Voltage Range	∆V _{CSH} _	Current-sharing range, VCSHP - VCSHN	-50		+50	mV
CSION Output Common-Mode Voltage	VCSION	With respect to AGND		1.29		V
CSIO_ Differential Input Resistance	R _{CSIO} _	ELEC	T R (IC	kΩ
CSHto-CSIO_ Current-Share Accuracy		V _{CSHP} – V _{CSHN} = 0mV	-2	0	+2	μA
CSHto-CSIO_ Transconductance	G _{M(CSH_)}			0.5		mS
CSIOto-COMP Transconductance	G _{M(CSIO_)}			0.19		mS

Note 1: Limits are 100% tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range and relevant supply-voltage range are guaranteed by design and characterization.

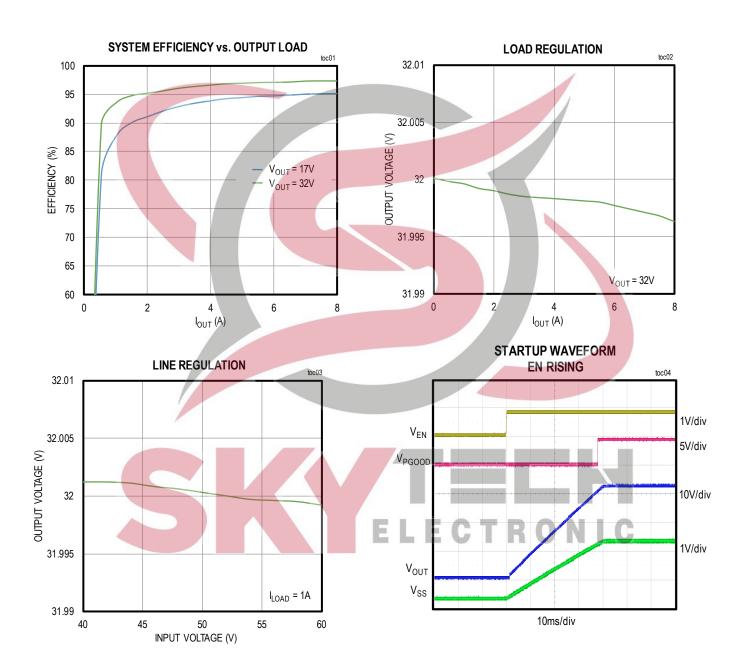
Note 2: Operating REFIN below 1V is not recommended due to disabled fault protection.

Note 3: Not tested, guaranteed by design.

60V Current Mode Buck Controller with Accurate Current Report

Typical Operating Characteristics

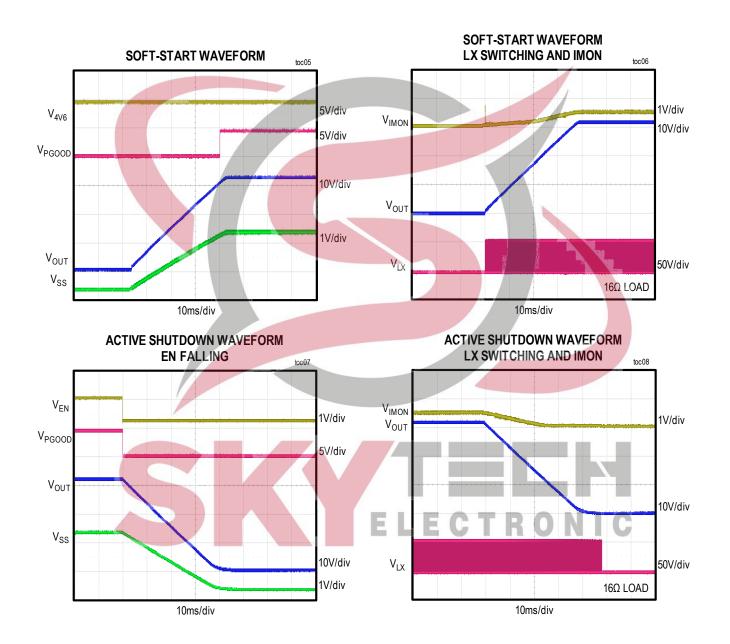
(T_A = -40°C to +125°C, V_{IN} = 55V, unless otherwise noted. See the Standard Application Circuit.)



60V Current Mode Buck Controller with Accurate Current Report

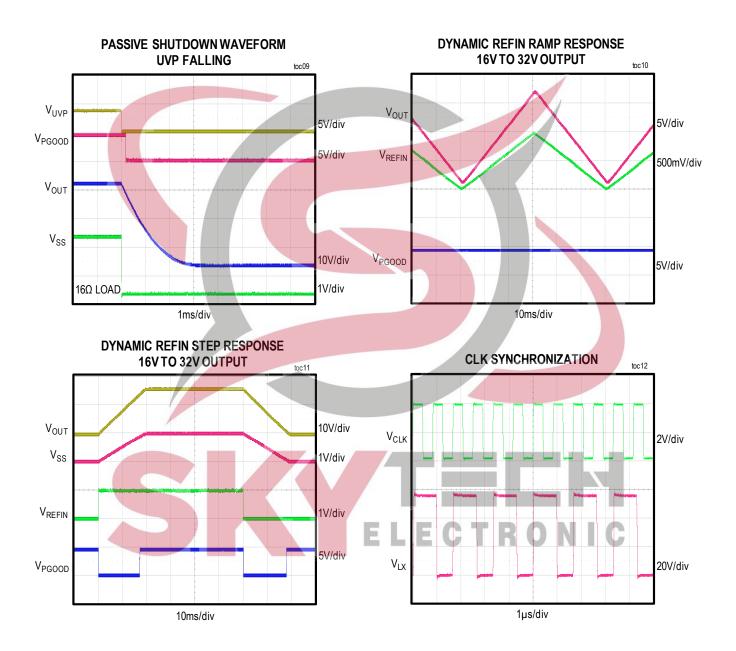
Typical Operating Characteristics (continued)

(T_A = -40°C to +125°C, V_{IN} = 55V, unless otherwise noted. See the Standard Application Circuit.)



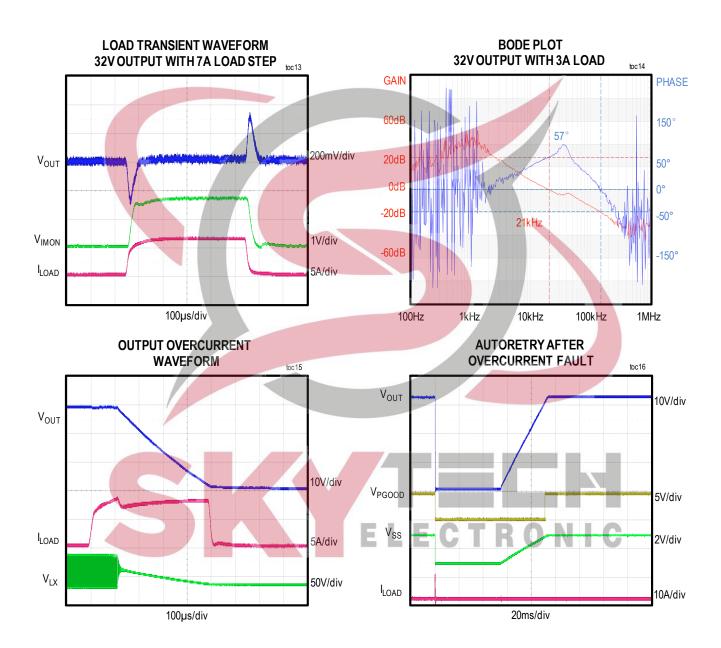
60V Current Mode Buck Controller with Accurate Current Report

Typical Operating Characteristics (continued) (T_A = -40°C to +125°C, V_{IN} = 55V, unless otherwise noted. See the <u>Standard Application Circuit</u>.)



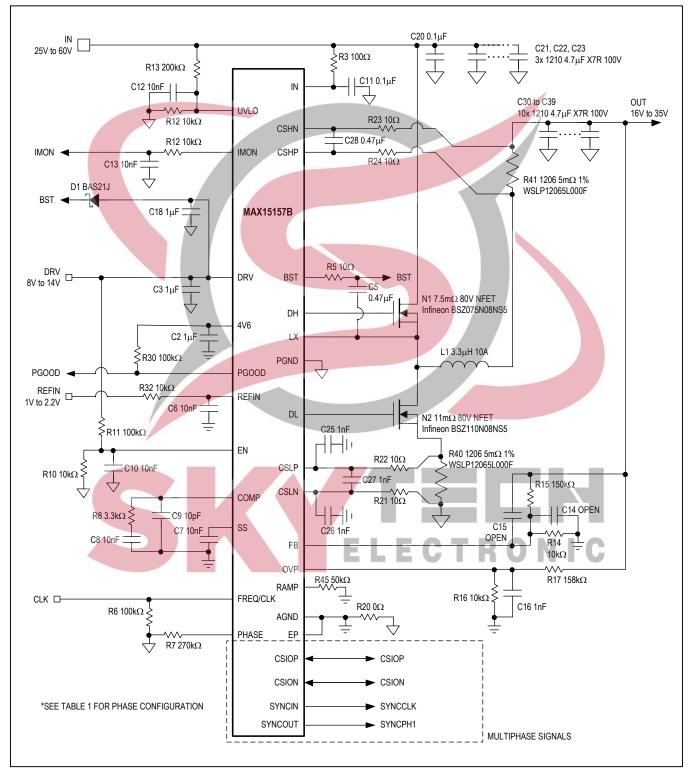
60V Current Mode Buck Controller with Accurate Current Report

Typical Operating Characteristics (T_A = -40°C to +125°C, V_{IN} = 55V, unless otherwise noted. See the <u>Standard Application Circuit</u>.)



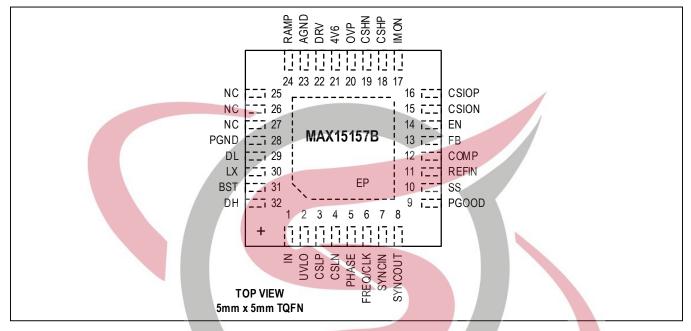
60V Current Mode Buck Controller with Accurate Current Report

Standard Application Circuit



60V Current Mode Buck Controller with Accurate Current Report

Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1	IN	Primary Input Supply. Connect IN to the 8V to 60V high-voltage system supply used to deliver power to the step-down power stage. IN serves as the system supply for the current-monitor amplifier and provides input undervoltage sensing.
2	UVLO	Adjustable Undervoltage-Lockout Input. When the UVLO voltage is below 0.9V, the device disables the controller. Connect UVLO to the center of a resistive-divider between the input and ground to adjust the undervoltage-lockout voltage, as shown in the <i>Standard Application Circuit</i> .
3	CSLP	Positive Low-Side Differential Current-Sense Input. The device uses the CSL_ differential current- sense signal in the current-mode control loop. Connect CSLP to the "MOSFET side" of the current- sense resistor located between the source of the low-side MOSFETs and PGND, as shown in the Standard Application Circuit.
4	CSLN	Negative Low-Side Differential Current-Sense Input. The device uses the CSL_ differential current- sense signal in the current-mode control loop. Connect CSLN to the "ground side" of the current- sense resistor located between the source of the low-side MOSFETs and PGND, as shown in the <i>Standard Application Circuit</i> .
5	PHASE	Synchronized Phase Selection. Connect to the 4V6 single-phase operations or refer to Table 1 for multiphase settings.

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Pin Description (continued)

PIN	NAME	FUNCTION
6	FREQ/CLK	Frequency Selection/Clock Synchronization Input. The device supports switching frequencies between 120kHz to 1MHz. Set the switching frequency by either selecting the appropriate external resistor to use the internal oscillator frequency, or by synchronizing the regulator to an external system clock (see Table 1). Leave FREQ/CLK unconnected to select the preset 300kHz switching frequency, or place a resistor to ground to set the following: $f_{SW} = (R_{FREQ}/100k\Omega) \times 600kHz$ For multiphase applications, FREQ/CLK serves as the master clock input.
7	SYNCIN	Synchronization Input/Clock Output for Multiphase Configurations. Connect SYNCIN to the SYNCOUT signal of the previous phase for multiphase synchronization. For the master phase, SYNCIN serves as the master clock output and should be connected to the FREQ/CLK input of all the power-stage phases (see Figure 2).
8	SYNCOUT	Multiphase Synchronization Output. Connect to the next phase when used in multiphase configurations (see Figure 2). For single-phase operation, leave SYNCOUT unconnected.
9	PGOOD	Open-Drain Power Good Output. The device pulls PGOOD low when the output voltage exceeds the OVP threshold, or below the output undervoltage-protection threshold, during soft-start and shutdown (EN pulled low). The PGOOD output goes high impedance when the controller completes soft-start and remains in regulation.
10	SS	Soft-Start Control. The capacitance (C _{SS}) between SS and AGND sets the startup period. An internal pulldown MOSFET holds SS low until the controller begins the startup sequence.
11	REFIN	External Reference Input. REFIN sets the feedback regulation voltage when supplied with a voltage between 0.4V and 2.2V. Operation between 0.4V < REFIN < 1V is possible but the FB_OV and FB_UV fault functions are disabled.
12	СОМР	Compensation Amplifier Output. COMP is the output of the internal transconductance error amplifier. Connect a type II compensation network, as shown in the <i>Standard Application Circuit</i> .
13	FB	Feedback Input. Connect FB to the center of a resistive divider between the output and AGND. FB regulates to the preset 2V feedback threshold (REFIN = 4V6), or tracks the REFIN voltage (REFIN between $0.4V$ and $2.2V$). Operation between $0.4V < REFIN < 1V$ is possible but the FB_OV and FB_UV fault functions are disabled.
14	EN	Enable Control Input. Pull EN below 0.55V to place the device into its low-power shutdown state. When disabled, the controller pulls PGOOD low, pulls all the driver outputs low, and turns off the bias regulator.
15	CSION	Negative Input of Multiphase Current-Sense Signal. The device uses a differential current-sense signal to ensure proper startup and current-balance behavior in multiphase configurations.
16	CSIOP	Positive Input of Multiphase Current-Sense Signal. The device uses a differential current-sense signal to ensure proper startup and current-balance behavior in multiphase configurations.
17	IMON	High-Side Current-Sense Amplifier Output. IMON amplifies the voltage sensed across the high-side current-sense resistor.
18	CSHP	Positive High-Side Differential Current-Sense Input. The device senses the output current across a high-side sense resistor. Connect CSHP to the inductor side of the current-sense resistor, as shown in the <i>Standard Application Circuit</i> . The controller amplifies this differential signal to generate the IMON current-monitor output voltage.

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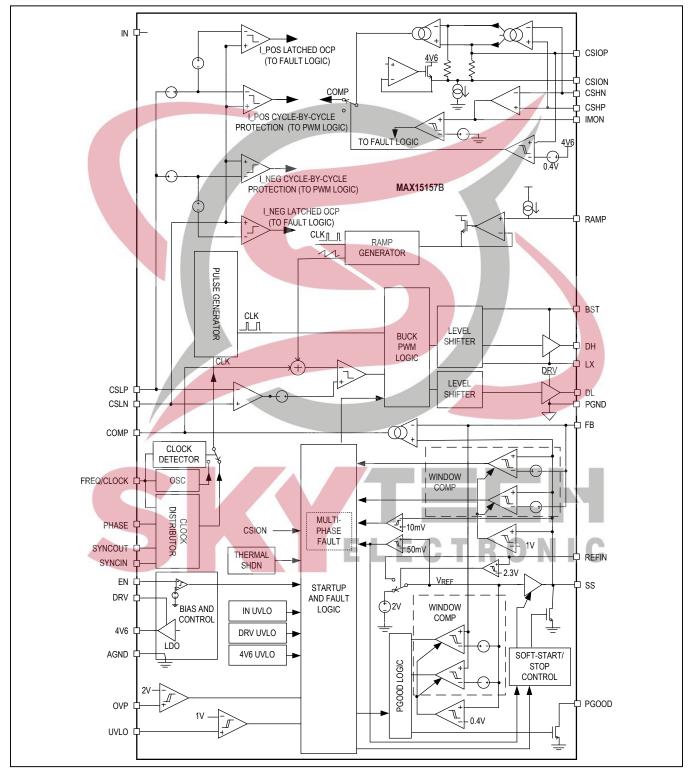
Pin Description (continued)

PIN	NAME	FUNCTION
19	CSHN	Negative High-Side Differential Current-Sense Input. The device senses the output current across a high-side sense resistor. Connect CSHN to the "output side" of the current-sense resistor, as shown in the <i>Typical Application Circuit</i> . The controller amplifies this differential signal to generate the IMON current-monitor output voltage.
20	OVP	Adjustable Output Overvoltage-Protection Threshold. Connect OVP to the center of an external resistive-divider network between the output and AGND to set the output overvoltage-protection limit.
21	4V6	4.6V Linear Regulator Output and Controller Bias Supply. Bypass to AGND with a 2.2 μ F or greater ceramic capacitor.
22	DRV	Driver Supply Voltage Input. Provides a 5.5V to 14V supply to power the low-side MOSFET gate drivers.
23	AGND	Analog Ground
24	RAMP	Slope Compensation Input. A resistor connected from RAMP to AGND programs the amount of slope compensation. See the <i>Programmable Slope Compensation</i> section.
25–27	NC	Not Connected
28	PGND	Power Ground. Connect PGND directly to the system ground plane.
29	DL	External Low-Side MOSFET Gate Driver. DL switches between DRV and PGND.
30	LX	Inductor Switch Node
31	BST	Boost Flying-Capacitor Connection. BST serves as the supply for the high-side driver. Connect to a Schottky diode from DRV to BST and an external 0.22nF, 25V ceramic capacitor between BST and LX, as shown in the Standard Application Circuit.
32	DH	External High-Side MOSFET Gate Driver. DH switches between BST and LX. The controller pulls DH low whenever the controller is disabled.
	EP	Exposed Pad. Connect EP to AGND.

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Block Diagram



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Detailed Description

The MAX15157B fixed-frequency, current-mode PWM controller drives two power MOSFETs in buck configuration, allowing the regulator to operate as a step-down regulator.

The switching frequency is controlled either through an external resistor setting the internal oscillator frequency, or by synchronizing the regulator to an external clock. The device is designed to support 120kHz to 1MHz switching frequencies.

The controller has a dedicated input undervoltage-lockout input (UVLO) and an accurate enable-input threshold for flexible power-sequence configuration. The regulator also has multiple fault-protection circuits to protect against overcurrent, output overvoltage, output undervoltage, and thermal shutdown. The MAX15157B monitors CSHP and latches off immediately when the voltage exceeds 65V.

Current-Mode Control Loop

The controller relies on a fixed-frequency, current-mode architecture to regulate the output. By using four MOSFETs and a single inductor, the buck configuration shown in the *Typical Application Circuit* allows the controller to regulate output voltages below the input voltage. The control loop uses a valley current-mode architecture to optimize performance with low duty cycles and provides the shortest possible minimum on-time.

The controller drives on the low-side MOSFET (DL driven high) on each clock edge. When the PWM comparator detects that the amplified low-side current-sense signal (CSLP to CSLN) and slope compensation have fallen below the COMP voltage, the controller pulls DL low and drives DH high.

Driver Supply (DRV)

In addition to the system input supply, the device requires an external driver supply. The MOSFET drivers require a 5.5V to 14V supply capable of supporting the supply current needed to drive the MOSFETs. The power loss through an internal linear regulator would be significant, so the driver supply typically comes from the regulated 12V system supply. The maximum current required is determined by the switching frequency (f_{SW}) and gatecharge of each MOSFET (Q_G):

 $I_{DRV} = 2f_{SW} \times Q_G$

Bias Regulator (4V6)

The controller includes an internal linear regulator that generates a regulated 4.6V bias supply to power the

internal analog and digital control circuitry. Bypass the regulator with a 1 μ F or greater ceramic capacitor to maintain noise immunity and stability. The DRV input supply powers the bias linear regulator to reduce the power loss, as shown in the <u>Block Diagram</u>. The 4V6 bias regulator provides up to 20mA of load current and the controller requires up to 5mA, so the remaining load capability can be used to support pullup resistors.

The 4V6 bias linear regulator and internal reference power up only when DRV exceeds its undervoltagelockout threshold and EN is driven high.

Input Undervoltage Lockout

The controller has input undervoltage-lockout thresholds on IN and DRV. The undervoltage-protection circuits inhibit switching until IN rises above 5.38V (typ) and DRV rises above 5.22V (typ).

If either supply drops below its undervoltage threshold, the controller determines that there is insufficient supply voltage to make valid control decisions. To protect the regulator and the output, the controller immediately pulls PGOOD low, disables the drivers (all driver outputs pulled low), and discharges the SS capacitor through an internal 5 Ω discharge MOSFET, placing the regulator into a high-impedance output state, so the output capacitance passively discharges through the load current.

Undervoltage-Lockout Pin (UVLO)

The external UVLO sense pin allows the input voltage operating range to be externally adjusted or for powersequence control. Either the input power source (IN) or driver supply (DRV) can be monitored. As long as UVLO exceeds and remains above 1V, the controller will power up and remain active. Once UVLO drops below 0.9V (typ), the controller pulls PGOOD low, disables the drivers (all driver outputs pulled low), and discharges the SS capacitor through an internal 5 Ω discharge MOSFET. The system can use the UVLO input as a secondary enable control pin; however, the controller remains powered (linear regulator and control circuitry biased) as long as the primary EN input remains high. Since the UVLO detection places the regulator into a high-impedance output state, the output capacitance passively discharges through the load current.

UVLO has a 6V absolute maximum voltage rating. Do not connect it directly to the high-voltage input power or driver supplies; short UVLO to the 4V6 bias supply if unused.

Soft-Start Sequence

The controller begins the startup sequence when both IN and DRV exceed their respective undervoltage-lockout thresholds, and after EN is driven high. With the controller enabled, the bias regulator and internal reference power up. Once the reference stabilizes, the regulator checks the UVLO input to determine if it exceeds 1V, checks the PHASE configuration, and determines if any preset settings are selected. During this initialization period, the controller pulls SS low through a 5 Ω discharge MOSFET.

The regulator charges the SS capacitor with a constant 5μ A current source until the SS voltage reaches either the preset 2V target voltage (REFIN = 4V6), or the externally driven REFIN voltage (V_{REFIN} = 0.4V to 2.2V). The drivers start switching once SS exceeds 50mV and the controller detects that FB voltage is below the SS voltage. The controller enables the fault-protection circuitry when SS exceeds 1V.

Shutdown (EN Pulled Low)

The device powers down using a soft-shutdown sequence when disabled by the EN input. Once EN drops below 0.55V, the controller pulls PGOOD low and begins to discharge the SS capacitor. Since the output voltage tracks the SS voltage, the regulator actively discharges the output capacitors. Once the SS and FB voltage reaches 10mV, the controller stops switching and enters a low-power shutdown state.

The controller discharges the SS capacitor using a 5μ A pulldown current. Below 100mV, the current mirror acts like a resistive load. The device does not restart until the soft-shutdown sequence has completed. During the soft-shutdown cycle, the fault protection remains active.

Adjustable Slope Compensation (RAMP)

The MAX15157B can operate at a duty cycle greater than 50%. It requires slope compensation to prevent subharmonic instability that occurs naturally in valley-current-mode-controlled converters operating in continuousconduction mode (CCM).

MAX15157B provides V_{RAMP} input to select the internal compensation ramp within a range of 130mV~600mV. The device allows the user to program this default value of 130mV slope compensation simply by shorting the RAMP pin to AGND. It is recommended that discontin-

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uous-mode designs also use this minimum amount of slope compensation to provide better noise immunity and jitter-free operation.

By connecting a resistor between RAMP and AGND, VRAMP is calculated as follows:

where:

 R_{RAMP} = The resistor connected between RAMP and AGND

I_{RAMP} = The current sourced from RAMP to AGND (6μA typ)

Hiccup Fault Protection

The MAX15157B features multiple hiccup-protection features (e.g., overcurrent protection, CSH_ overvoltage protection, and thermal shutdown) that trigger an autorestart of the regulator. Whenever any protection event is triggered, the regulator disables the drivers (all driver outputs pulled low), and discharges the SS capacitor through a 5 Ω pulldown MOSFET. After 32,768 clock cycles, the regulator automatically attempts to restart using the soft-start sequence.

Undervoltage Protection (UVP)

The device monitors the FB voltage for an output undervoltage-fault condition. If the feedback voltage drops 9% (typ) below the SS voltage for at least 20µs, the controller discharges the SS capacitor and tristates the drivers. The controller immediately restarts once the fault condition has been removed.

Overvoltage Protection (OVP)

The MAX15157B has three separate OVP comparators: the first monitors the FB voltage, the second monitors the high-side current-sense input (CSHN), and the third monitors the independent OVP input. The FB overvolt-age comparator trips if the feedback voltage exceeds the SS voltage by 9% (typ) for more than 20µs. The CSH_ overvoltage comparator trips if the current-sense voltage exceeds 65V, which is the operating limit of the regulator and current-sense amplifier. Finally, the OVP comparator trips if it exceeds 2V.

If the independent OVP input is not used, then short OVP to AGND. Alternatively, the independent OVP input can be used to monitor the input supply

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Thermal Shutdown (TSHDN)

The controller features a thermal fault-protection circuit. When the junction temperature rises above $+165^{\circ}$ C, the internal thermal sensor triggers the hiccup-fault protection, disables the drivers, and discharges the SS capacitor. The controller remains disabled until the junction temperature cools by 15°C. Once the device has cooled down and at least 32,768 clock cycles have expired, the controller automatically restarts using the soft-start sequence.

Switching Frequency (FREQ/CLK)

The controller supports 120kHz to 1MHz switching frequencies. Leave FREQ/CLK unconnected to select the preset 300kHz switching frequency. To adjust the switching frequency, either place an external resistor from FREQ/CLK to AGND, or drive FREQ/CLK with an external system clock (see Table 1). The resistively programmable switching frequency is determined by:

 $f_{SW} = (R_{FREQ}/100k\Omega) \times 600kHz$

RPHASE

133kΩ

Table 1. PHASE Configuration

PHASE VOLTAGE

1.33V ± 0.05V

PHASE

The PHASE input selects single-phase operation, or is used in multiphase operation to determine phase identity. This identification is used to determine how the controller responds to the multiphase clock signal generated by the primary phase.

Integrated High-Side Current Monitor (IMON)

The controller also includes a high-side current-sense amplifier. The current-monitor output drives a voltage that is equivalent to 50x the differential CSHP-to-CSHN voltage. The current-sense amplifier only functions in a single quadrant, so the controller only monitors current sourced to the output (Figure 1).

The IMON output is compared with a 2.5V threshold. Once the V_{IMON} exceeds 2.5V more than 32 consecutive clock cycles, the part enters hiccup mode (see Figure 1).

CONFIGURATION

1.68V ± 0.05V	169kΩ	3 Phase	2-FET	6 x f _{SW}
2.09V ± 0.05V	210kΩ	4 Phase	Step-Down	4 x f _{SW}
> 2.48V	270kΩ	1 Phase		2 x f _{SW}
0				
	0.1μF		R3 100Ω	
	MAVAGAGZD		>	

NUMBER OF PHASES

2 Phase

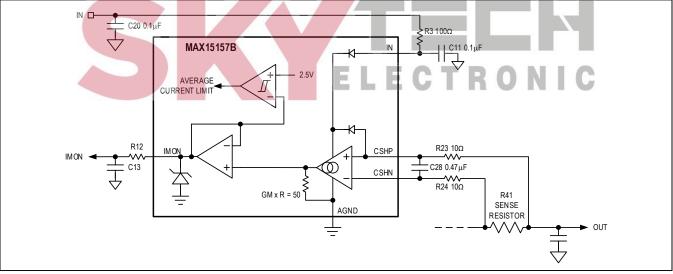


Figure 1. High-Side Output Current Monitor

CLK FREQUENCY

2 x f_{SW}

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MOSFET Gate Drivers

The MAX15157B uses 12V gate drivers optimized for driving 80V power MOSFETs required for the typical high-voltage application. The drivers use a 2 Ω pullup and 0.6 Ω pulldown to quickly turn on and off the MOSFETs. These strong gate drivers are required to support high-frequency operation and minimal on-time/off-time periods.

The regulator powers the DH high-side drivers by BST and LX. When switching, the BST voltage is determined by the charge-pump circuit formed by the DRV-to-BST high-voltage Schottky diode, BST-to-LX capacitor, and low-side MOSFET. The Schottky diode used should be rated at $V_{IN(MAX)}$ + 30V.

Adaptive dead-time circuits monitor the DL-to-DH drivers, preventing either driver from turning on its MOSFET until the other MOSFET has fully turned off. The adaptive shoot-through protection allows robust operation with a wide range of MOSFETs, while minimizing dead-time power losses. The layout must provide a low-resistance, low-inductance path between the driver outputs and the MOSFET gates for the adaptive dead-time circuits to function properly; otherwise, the sense circuitry in the controller interprets the MOSFET gates as "off" while charge remains.

Multiphase Application Description

Multiphase Synchronization

For proper synchronization between phases in a multiphase configuration, the SYNCIN of the master device acts as a master clock. Connect this SYNCIN output to the FREQ/CLK signals of all the slave devices.

Additionally, the interleaved phase control is communicated by connecting the SYNCOUT signal to the SYNCIN input of the next phase. The daisy-chained signal ensures that the phases run out-of-phase. The PHASE setting communicates the frequency that the master SYNCIN signal must run at, and the clock count needed to maintain out-of-phase operation.

Multiphase Current-Balance (CSIO_)

The device uses the differential CSIO_ connection at startup to configure the multiphase configuration. Once this configuration period is complete, the differential interconnect communicates the average per-phase current of each regulator. The current-mode slave devices regulate their current so that all phases share the output load.

PCB Layout

Component Placement (See the <u>Standard</u> Application Circuit)

Input and Output

Group input power path components input capacitor (C21, C22, C23), switch N1, switch N2 and D1 in one compact area.

The current path of switch N1, switch N2, D1 and the input capacitor should be minimized as small as possible.

Place switch N2 as close as possible to the controller, keeping the PGND, DL, and SW traces short. Currentsense R40 needs to be close to N2, and input and output capacitors.

The output capacitor (-) terminals should be connected as close as possible to the (-) terminals of the input capacitor.

High dV/dt Device

Keep the high dV/dT LX, BST, and DH nodes away from sensitive small-signal nodes.

Control-Loop Component

RC network associated with controller IC are preferred to be at the same layer.

PCB Routing (See the <u>Standard</u> Application Circuit)

Input Trace

Use planes for input and output voltage to maintain good voltage filtering and to keep power losses low. Route the traces as close as possible for the (+) terminals and (–) terminals of the input and output capacitors.

Ground

Since PGND is in path of input and output (load) currents, it is very important to have enough vias connecting it to the inner PGND layers. The case is the same for input voltage.

Separate the signal and power grounds. All small-signal components should return to the AGND pin at one point, which is then tied to the PGND pin through R20 to sense resistor R40, which is close to the sources of switch N2.

The second layer from top and bottom should be reserved for contiguous GND planes (electrical and thermal reasons). "Quiet GND" on the MAX15157B should be a contained shape right under the chip on one of the inner layers, and be connected to other AGND in one point through a single via.

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REFIN should be referred to the AGND. Do not refer it to PGND. Any offset from PGND impacts the voltage regulation accuracy.

Use immediate vias to connect the components (including the MAX15157B's AGND and PGND pins) to the ground plane. Use several large vias for each power component.

High dV/dt and di/dt Loop

Connect the top driver bootstrap capacitor, C18, closely to the BST and LX pins.

Connect the input capacitors and output capacitors closely to the power MOSFETs. These capacitors carry the MOSFET AC/switching current in boost and buck operation.

Thermal

Add enough copper planes for each termination of power inductor/MOSFET. The layout needs to meet the thermal current PCB guideline per inductor/MOSFET spec.

Flood all unused areas on all layers with copper. Flooding with copper reduces the temperature rise of power components. Connect the copper areas to any DC net (V_{IN} or PGND).

Exposed Pad

The exposed pad (EP) works as heatsink to dissipate the heat generated from the silicon power loss. It is important to provide a relatively quiet AGND for the device to operate properly. Connect EP to AGND. The exposed pad must be soldered evenly to the PCB ground plane for proper operation and power dissipation. Use multiple vias beneath the exposed pad for maximum heat dissipation. A 1.0mm to 1.2mm pitch is the recommended spacing for these vias and they should be plated (1oz copper) with a small barrel diameter (0.30mm to 0.33mm).

Multiphase Interconnections

Master and slaves are connected through multiple analog lines. Use the shortest direct path for these connections. Try to avoid layer changes.

Have a thick trace (or another long shape) going from the Master "quiet GND" to all of the slaves. The master controller should share the same AGND with the slaves. For proper synchronization between phases in a multiphase configuration, connect this SYNCIN output to the FREQ/ CLK signals of all the slave devices. Have traces of SYNCIN and SYNCOUT, CSIOP and CSION coupling with AGND and 4V6BIAS. Carefully arrange the AGND between phases so that no additional offset is added to CSIO_ pins.

All lines should be routed from each slave together and far away from any known source(s) of noise.

Keep the FREQ/CLK, SYNCIN, and SYNCOUT lines far away from CSIO_one to avoid unnecessary noise coupling.

Use inner layers for these connections in order not to cut into the power paths on top and bottom layers.

CSIO_ signals should be routed away from the high load current paths of the slaves IC and in between AGND planes for best shielding. These signals should be routed in internal layers to avoid cutting of top- and bottom-layer power-delivery planes compromising regulator efficiency.

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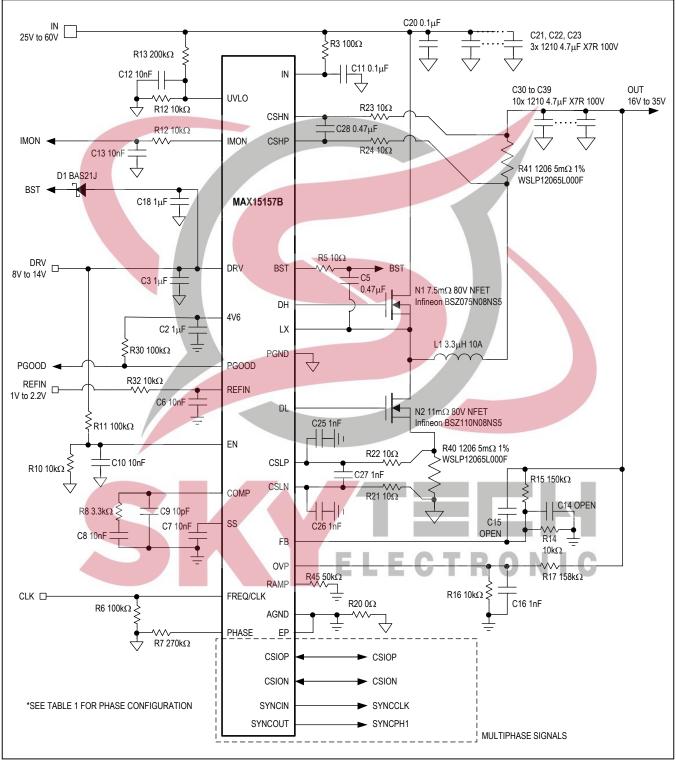


Figure 2. Single-Phase Buck Converter

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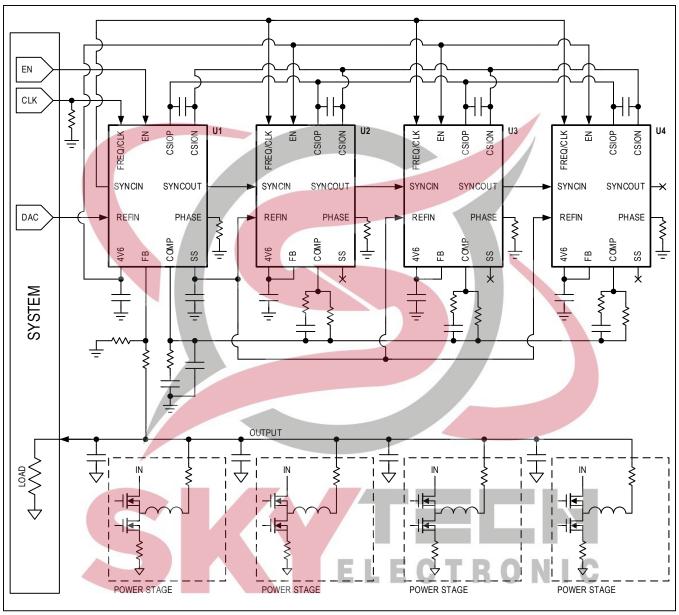


Figure 3. Multiphase Interconnects

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Ordering Information

PART	TEMP RANGE	PIN-PACKAGE		
MAX15157BATJ+	-40°C to +125°C	32 TQFN-EP*		
· Demotes a la ad//Dh) fra a /Da/10 as marliant realized				

+Denotes a lead(Pb)-free/RoHS-compliant package. *EP = Exposed pad.

Chip Information

PROCESS: CMOS



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Revision History

REVISIO NUMBE		DESCRIPTION	PAGES CHANGED
0	1/17	Initial release	—



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